

# **Real-Time Electromagnetic Transient Simulation of AC-DC Networks**



# Venkata Dinavahi, Ning Lin





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## ॐ भूर्भुवः स्वः तत्संवितुर्वरेण्यं । भर्गो देवस्य धीमहि धियो यो नंः प्रचोदयांत् ॥

Om bhūrbhuvaḥ svaḥ tatsaviturvarenyam; bhargo devasya dhīmahi dhiyo yo nah pracodayat.

We meditate on that most adored Supreme Soul, the Creator, whose effulgence illumines all realms. May this divine light illumine our intellect.

Dedicated to our parents: Late Smt. Dinavahi Sasirekha and Shri. Dinavahi Ramarao Liyue Xie and Quanyao Lin

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#### <span id="page-22-0"></span>**Preface**

ulators in the 1970s through to the 1990s, one of their principal applications has Promising advances in high-power electronics and the challenges facing modern power system operation in terms of integration of large-scale renewable generation and energy storage is necessitating the construction of high-voltage direct current (HVDC) transmission worldwide. Meshed multi-terminal DC grids are transporting bulk energy over longer distances, interconnecting far-flung asynchronous AC network, and are being operated with higher redundancy, efficiency, and reliability. Since the conception of real-time analog simulators (known as transient network analyzers (TNAs)) and subsequently real-time digital power system simbeen for the testing of control and protection functions in a hardware-in-the-loop (HIL) configuration for HVDC systems prior to their commissioning. Currently, real-time digital electromagnetic transient (EMT) simulators are used in every sector of electrical power chain: generation, transmission, distribution, and consumption. Moreover, real-time EMT simulators are also frequently employed in the transportation (automotive and railway traction), aviation, and marine industries, wherein the electrical systems share many structural and functional commonalities with terrestrial AC–DC networks. While the design, testing, and commissioning of local control and protection functions of system equipment is the primary objective of real-time EMT simulation, it is also paramount for global dynamic and interactive studies of large-scale power systems for wide-area control, protection, and system operator training. EMT simulation of large AC–DC grids in real time is a significant challenge due to the need for detailed device-level modeling of system components while simultaneously reproducing the system-level interactions accurately by accommodating large system sizes. These contrasting requirements place an enormous burden on the simulator latency constraints and the hardware selection for implementing the real-time simulation.

> EMTs are the consequence of the interplay between the electric and magnetic fields in power system equipment when the system is perturbed from its steady-state operation by an event such as the switching of a line, a

#### **xxii** *Preface*

the computational burden experienced by the simulator. The selection of model fault, or a lightning strike. A widely accepted classification of EMT is into four categories: low-frequency oscillations (0.1 Hz–3 kHz) e.g. temporary overvoltages, slow-front surges (50 Hz–20 kHz) e.g. switching overvoltages, fast-front surges (10 kHz–3 MHz) e.g. lightning overvotages, and very fast-front surges (100 kHz–50 MHz) e.g. circuit breaker restrike overvoltages. The switching on and off of power semiconductor devices such as insulated gate bipolar transistors (IGBTs) also generates transients albeit at the device-level, and they are typically in the 1–20 MHz range. The transients propagate near to the speed of light from their inception point and spread throughout the system causing extensive damage if not interrupted or absorbed. Of all the studies done in power systems, the modeling required to simulate EMT is the most complex. The higher the frequency of the transient, the more complex the modeling of any equipment becomes and the smaller the size of the network it spreads to. Conversely, low-frequency transients entail simpler modeling of equipment and propagate over a wider scale requiring the analysis of a larger network. For a particular EMT case study, the factors that influence the modeling complexity of any equipment are the distributed nature of parameters, frequency-dependency, and the inherent nonlinearities in the device. Accordingly, the extent to which each of these phenomena is accurately modeled for every equipment determines decomposition strategy, numerical solution algorithm, and time-step also depends on these same factors. All of the above considerations need to be observed to successfully design and implement a real-time EMT simulation.

> Of the many digital processors currently available on the market, fieldprogrammable gate arrays (FPGAs) are the sole processor technology capable of meeting the rigorous real-time constraints and large hardware resource capacity required for AC–DC grid emulation with detailed equipment modeling. FPGAs contain numerous configurable logic resources, distributed memory, and inputs/outputs that can provide massive hardware parallelism for emulating detailed power system component models simultaneously. Currently available commercial FPGAs offer millions of logic gates, high-bandwidth on-chip memory, and ultrafast transceivers. The recent development of FPGA technology is not only in terms of improving their timing performance and enlarging their hardware resource capacity but also in terms of streamlining an integrated design tool ecosystem. The high-level synthesis (HLS) design methodology using C/C++ programming language instead of the conventional hardware description language (HDL) is explored as a new means of modularizing the AC–DC grid to reduce the hardware design cycle while maintaining a high synthesis efficiency. The synthesized hardware modules can then be pipelined efficiently with optimized performance regarding the resource usage and latency requirements.

Chapters 3 and 4 cover power transformers and rotating electrical machines This book intends to provide a detailed exposition of FPGA hardware based real-time EMT emulation for the fundamental components used in AC–DC power systems. Specific focus is afforded to detailed device-level models for their hardware realization in a massively parallel and deeply pipelined manner, and decomposition techniques for emulating large systems. In the various chapters of the book, while the hardware emulation may have been done on FPGAs from different generations or vendors, the underlying principles of model decomposition and parallel solution algorithms are generally applicable on any device. This book is intended for two groups of readers: graduate students in a university and professional research engineers and scientists in the industry. University students pursuing masters and doctoral degrees will find state-of-the-art presentation of the material on real-time EMT simulation of AC–DC grids. Such material can inspire and motivate advanced research ideas for their projects, dissertations, and publications. For industry experts, the book provides relevant academic research developments and implementation knowledge that they can incorporate in their respective product development process. The book is organized as follows: after giving a brief introduction of FPGA architecture and design flow in Chapter 1, Chapter 2 introduces the concepts of hardware emulation building blocks for fundamental power system components necessary for real-time EMT simulation: linear lumped passive elements, transmission lines, and nonlinear elements. building from simpler lumped linear models to detailed nonlinear magnetic equivalent circuit based models and finite element models. Chapter 5 describes the hardware emulation techniques for digital protective relays. Chapter 6 addresses the emerging and challenging topic of adaptive time-stepping based real-time EMT simulation. Chapter 7 discusses power semiconductor component models and their hardware emulation varying in complexity from simple system-level switch models to detailed device-level nonlinear behavioral and physics-based electrothermal models. Chapters 8–10 cover the modeling and emulation of various building blocks of DC grids: AC/DC converters, DC/DC converters, and DC circuit breakers. Finally, Chapter 11 culminates in examining the challenge of real-time EMT simulation of large-scale AC and DC grids.

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### <span id="page-28-0"></span>**List of Acronyms**



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### **xxviii** *List of Acronyms*

